## 502441646 07/31/2013

## PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
Yeon Ok KIM	12/18/2012

## **RECEIVING PARTY DATA**

Name:	SK hynix Inc.
Street Address:	2091, Gyeongchung-daero, Bubal-eub
City:	Icheon-si, Gyeonggi-do
State/Country:	KOREA, REPUBLIC OF

#### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	13720497

## **CORRESPONDENCE DATA**

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ATTORNEY DOCKET NUMBER:	95091-857986 (180600US)
NAME OF SUBMITTER:	Kelly Pedersen
Signature:	/Kelly Pedersen/
Date:	07/31/2013

Total Attachments: 2

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PATENT

REEL: 030917 FRAME: 0738

# ASSIGNMENT

(Patent Application)

We [I], the undersigned, have invented certain inventions and improvements disclosed in a utility (provisional or non-provisional) or design patent application entitled

## "MULTI-CHIP SEMICONDUCTOR APPARATUS"

the	specificat	ion of	which is	provided with	this	Assignment and	identified by	the
Attorney	Docket	No.	above.	(Serial	No.	13/720,497	filed	on
December	19, 2012		)					

For one dollar (\$1.00) and other good and valuable consideration, the receipt and sufficiency of which we [I] acknowledge, we [I]:

- 1. Agree to assign, transfer, convey, and sell, hereby assign, transfer, convey, and sell and have assigned, transferred, conveyed, and sold to SK hynix Inc., a corporation of Korea having a principal place of business at 2091, Gyeongchungdaero, Bubal-eub, Icheon-si, Gyeonggi-do, Republic of Korea ("Assignee"), the entire right, title, and interest in and to:
  - (a) all intellectual property (including, without limitation, any innovation, information, invention, discovery, product, process, work or design) disclosed, embodied, shown, or claimed in the above-referenced patent application, implicitly or explicitly;
  - (b) the above-referenced patent application, the right to claim priority to the above-referenced patent application, all applications based in whole or in part upon the above-referenced patent application, including, without limitation, all applications that are a provisional, non-provisional, design, divisional, continuation, continuation-in-part, registration, utility model, industrial design, reissue, renewal, substitute, extension, reexamination, post-grant review, inter partes review, supplemental examination or non-U.S. patent application or application for other rights based in whole or in part on the above-referenced patent application;
  - (c) all patents (including, without limitation, all U.S. and non-U.S. patents, registrations, utility models, industrial designs, design patents, counterparts, continuations, continuations-in-part, divisionals, reissues, renewals, substitutes, extensions, reexaminations, post-grant reviews, inter partes reviews and supplemental examinations) that are granted or issued upon, or that claim priority to, any and all applications described in (b) of this paragraph or that disclose or claim intellectual property described in (a) of this paragraph, in whole or in part; and

PATENT REEL: 030917 FRAME: 0739 ASSIGNMENT MULTI-CHIP SEMICONDUCTOR APPARATUS Attorney Docket No. 95091-857986 (180600) Page 2 of 2

- (d) all claims for damages by reason of past infringement of any rights under the applications or patents described in (a), (b) or (c) of this paragraph (including provisional rights to reasonable royalties pursuant to 35 U.S.C. §154(d)) and the right to sue for and collect such damages and royalties for Assignee's own use.
- 2. Authorize and request the U.S. Patent and Trademark Office or any other U.S. or non-U.S. agency to issue to the Assignee any and all patent(s), or other rights or documents, resulting from the intellectual property, patent application(s) and patents described in paragraph 1 of this Assignment.
- 3. Agree to sign all papers and documents, including without limitation, applications, declarations, oaths and petitions, and, at the Assignee's expense, perform any other acts that are necessary in connection with prosecution of patent application(s) or intellectual property described in paragraph 1 of this Assignment and the enforcement of patent(s) or other rights resulting from such patent application(s) or intellectual property.
- 4. Agree that the terms, covenants, and conditions of this Assignment shall inure to the benefit of the Assignee, its successors, assigns and other legal representative, and shall be binding upon us [me], as well as our [my] heirs, legal representatives, and assigns.
- 5. Promise and affirm that we [I] have not entered, and will not enter, into any assignment, contract, or understanding that conflicts with this Assignment.
- 6. Authorize Kilpatrick Townsend & Stockton to insert above the application number and filing date of the above-described patent application when known.

Signed on the dates indicated beside our [my] signatures [signature].

Signature:	Yeon Ok	KTH	Date: 2012-12-18		
-	Yeon Ok KIM				

PATENT REEL: 030917 FRAME: 0740

**RECORDED: 07/31/2013**